



光继电器

Photo Relay

QX414S

宁波群芯微电子股份有限公司

NINGBO QUNXIN MICROELECTRONICS CO., LTD.

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概述 Description

QX414S 光继电器由红外发光二极管和光电发生器、MOSFET 组成。

The QX414S Photo relay consist of a photo MOSFET、Photovoltage generator、infrared LED.

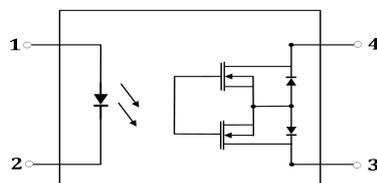
特性 Features

- 常闭,单刀单掷
Normally closed (SPST)
- 控制 400V 交流或直流电压
Control 400V AC or DC voltage
- 开关 120mA 负载
Switch 120mA load
- 控制低电平模拟信号
Controls low-level analog signal
- 高灵敏度, 低导通电阻
High sensitivity, low conductivity resistance
- 低电平关断漏电流
Low-level off state leakage current
- 高隔离电压 3750V_{rms}
High isolation voltage 3750V_{rms}
- 无铅, 符合 RoHS 标准
Lead free, meet RoHS standards

应用 Applications

- 通讯产品(个人电脑,笔记本电脑)
Communications products (Personal computers, Laptops)
- 调制解调器/传感器
Modem/Sensor
- 移动电话 /安全设备
Mobile phones/Security equipment
- 测量和测试设备
Measuring and Testing equipment
- 工厂自动化设备
Plant automation equipment
- 高速检验机器
High-speed inspection machines

封装和原理图 Package and Schematic Diagram



Pin Configuration

1. ANODE
2. CATHODE
3. DRAIN
4. DRAIN

产品型号命名规则 Order Code

QX 414S - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦

- ① 公司代码 Company Code (QX: 群芯 Qunxin)
- ② 产品系列 Product Series (414S: 414S)
- ③ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ④ 树脂类型 Epoxy Type (H: 无卤 Halogen-free)
- ⑤ 封装形式 Package (S: SOP)
- ⑥ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填写或者空白 Special Range need to be filled in or left blank)
- ⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

印字信息 Marking Information

- 印字中“”为群芯品牌 LOGO
“”denotes LOGO
- 印字中“Y”代表年份: A(2018), B(2019), C(2020).....
“Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号
“WW”denotes Week's number
- 印字中“N”代表星期几
“N”denotes the day of the week
- 印字中的“H”代表无卤
“H”denotes Halogen-free
- 印字中的“V”代表产品特殊标识: A~Z 或空白
“V”denotes Product special code: A~Z or None



绝缘和安规信息 Insulation and Safety related specifications

| 项目 Item | 符号 Symbol | 数值 Value | 单位 Unit | 备注 Note |
|---------------------------------------|--------------|-------------|------------|---|
| 爬电距离 Creepage Distance | L | 5.0 | mm | 从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body. |
| 电气间隙 Clearance Distance | L | 5.0 | mm | 从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air. |
| 绝缘距离 Insulation Thickness | DTI | 0.3 | mm | 发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector. |
| 峰值隔离电压 Peak Isolation Voltage | V_{IORM} | 600 | V_{peak} | DIN/EN/IEC EN60747-5-5. |
| 瞬态隔离电压 Transient Isolation Voltage | V_{IOTM} | 5000 | V_{peak} | DIN/EN/IEC EN60747-5-5. |
| 隔离电压 Isolation Voltage | V_{ISO} | 3750 | V_{rms} | For 1 minute. |

极限参数 Absolute Maximum Ratings ($T_A=25^{\circ}C$)

| 参数 Parameter | | 符号 Symbol | 额定值 Rating | 单位 Unit |
|---------------------------------|---------------------------------------|--------------|---------------|-------------|
| 发射端 Input | LED 正向电流 LED Forward Current | I_F | 50 | mA |
| | LED 反向电压 LED Reverse Voltage | V_R | 5 | V |
| | 峰值正向电流 Peak Forward Current | I_{FP} | 1 | A |
| | 输入功率 Power Dissipation | P_{in} | 75 | mW |
| 接收端 Output | 负载电压(AC 峰值) Load Voltage (Peak AC) | V_L | 400 | V |
| | 持续负载电流 Continuous Load Current | I_L | 0.12 | A |
| | 峰值负载电流 Peak Load Current | I_{peak} | 0.3 | A |
| | 输出功率 Power Dissipation | P_{out} | 300 | mW |
| 输入输出瞬态耐受电压 Isolation Voltage | | V_{ISO} | 3750 | V_{rms} |
| 工作温度 Operating Temperature | | T_{opr} | -40~+85 | $^{\circ}C$ |
| 存储温度 Storage Temperature | | T_{stg} | -40~+100 | $^{\circ}C$ |
| 焊接温度 Soldering Temperature | | T_{sol} | 260 | $^{\circ}C$ |

产品特性参数 Electro-optical Characteristics ($T_A=25^{\circ}\text{C}$)

| 参数 Parameter | | 符号 Symbol | 条件 Condition | 最小 Min. | 典型 Typ. | 最大 Max. | 单位 Unit |
|-------------------------------------|---|-------------------|---|------------|------------|------------|---------------|
| 发射端 Input | LED 动作(关闭)电流 LED Operate (OFF) Current | I_{Foff} | $I_L = 0.12\text{A}$ | - | 0.35 | 3 | mA |
| | LED 复位(开启)电流 LED Reverse (ON) Current | I_{Fon} | $I_L = 0.12\text{A}$ | 0.1 | 0.3 | - | mA |
| | LED 正向压降 LED Dropout Voltage | V_F | $I_F = 5\text{mA}$ | - | 1.3 | 1.5 | V |
| 接收端 Output | 导通电阻 On Resistance | R_{on} | $I_F = 0\text{mA}$, $I_L = 0.12\text{A}$ Within 1s on time | - | 28 | 60 | Ω |
| | 关断漏电 Off State Leakage Current | I_{Leak} | $I_F = 5\text{mA}$ $V_L = 400\text{V}$ | - | - | 1 | μA |
| 传输特性 Transfer Characteristics | 动作(关闭)时间 Operate (OFF) Time | T_{off} | $I_F = 0\text{mA} \rightarrow 5\text{mA}$ $I_L = 0.12\text{A}$ | - | 50 | 1000 | μs |
| | 复位(开启)时间 Reverse (ON) Time | T_{on} | $I_F = 5\text{mA} \rightarrow 0\text{mA}$ $I_L = 0.12\text{A}$ | - | 250 | 1000 | μs |
| | I/O 电容 I/O Capacitance | C_{ISO} | $f = 1\text{MHz}$ $V_B = 0\text{V}$ | - | 0.8 | 1.5 | pF |
| | 初始 I/O 隔离电阻 Initial I/O Isolation Resistance | R_{ISO} | 500 V DC | 1000 | - | - | M Ω |

典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 LED Dropout Voltage vs. Ambient Temperature

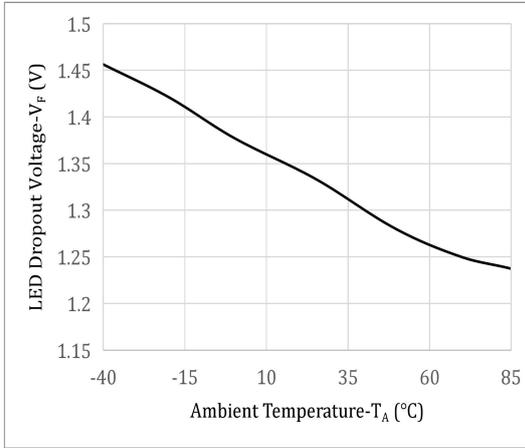


Fig.2 Output Current vs. Output Voltage

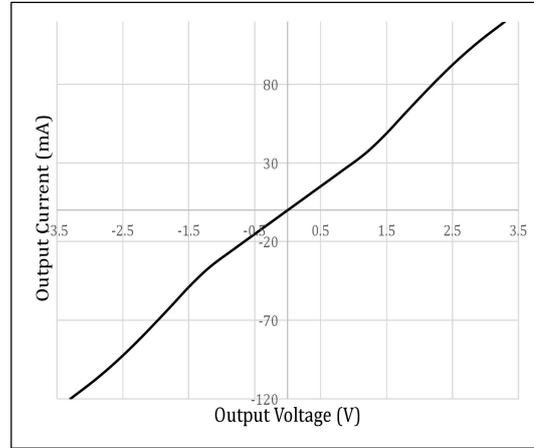


Fig.3 On Resistance vs. Ambient Temperature

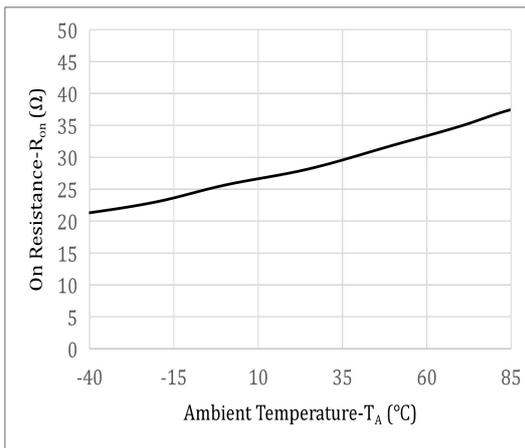


Fig.4 Load Current vs. Ambient Temperature

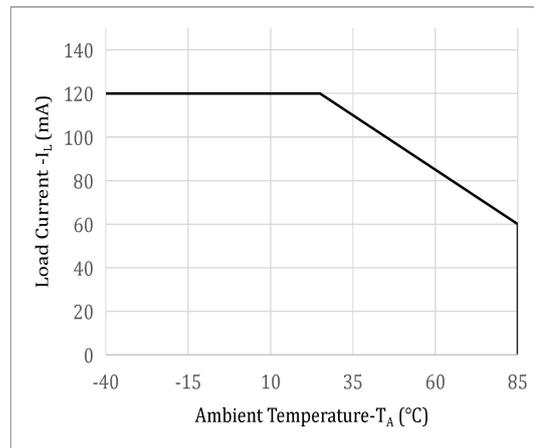


Fig.5 LED Operate (OFF) Current vs. Ambient Temperature

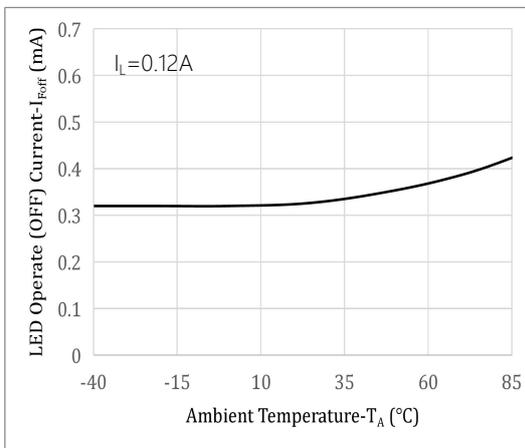


Fig.6 LED Reverse (ON) Current vs. Ambient Temperature

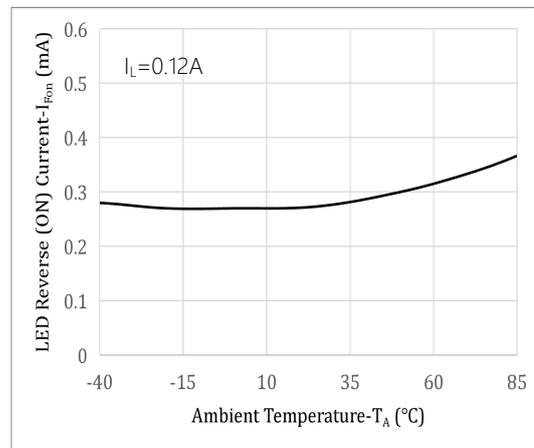


Fig.7 Operate (OFF) Time vs. Ambient Temperature

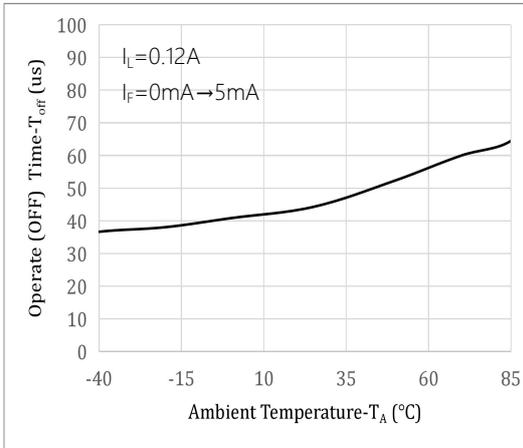


Fig.8 Reverse (ON) Time vs. Ambient Temperature

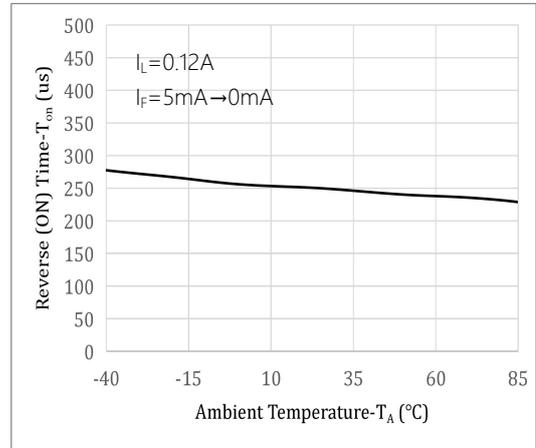


Fig.9 Operate (OFF) Time vs. LED Forward Current

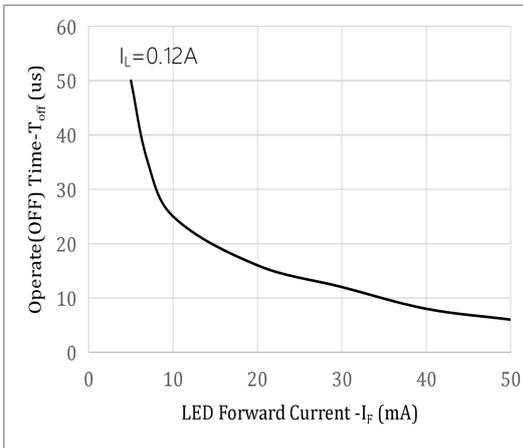


Fig.10 Reverse (ON) Time vs. LED Forward Current

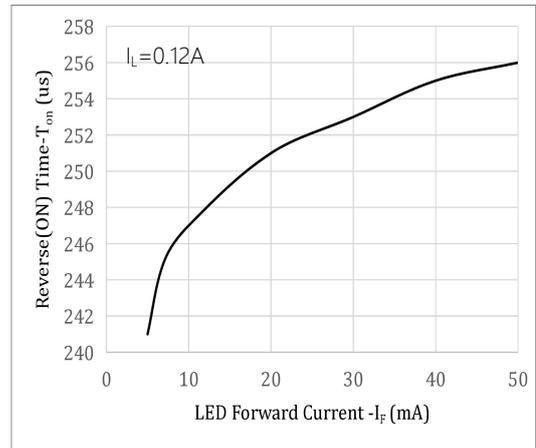
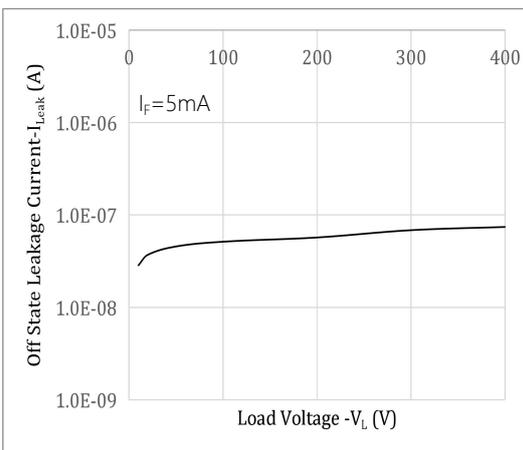
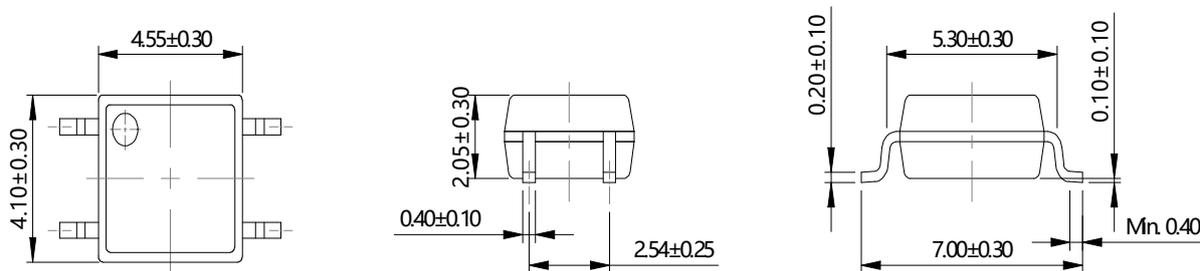


Fig.11 Off State Leakage Current vs. Load Voltage



外形尺寸 Outline Dimensions

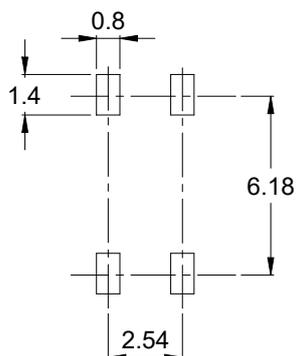
SOP4



5 单位 Unit:

mm

建议焊盘布局 Recommended Pad Layout

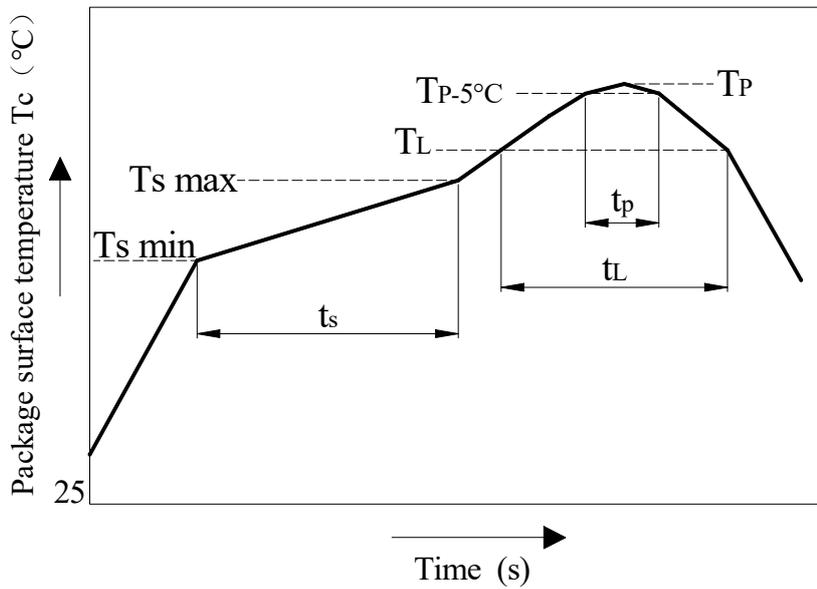


单位 Unit: mm

注：上图为产品正视图。

Note: The picture above is the front view of the product.

回流焊温度曲线图 Solder Reflow Profile

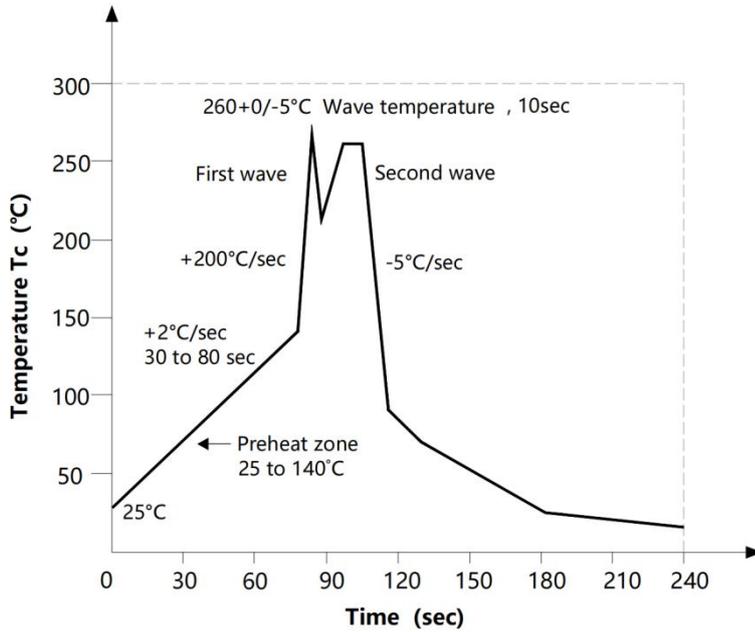


| 项目 Item | 符号 Symbol | 最小值 Min. | 最大值 Max. | 单位 Unit |
|---|--------------|-------------|-------------|---------------------------|
| 预热温度 Preheat Temperature | T_s | 150 | 200 | $^\circ\text{C}$ |
| 预热时间 Preheat Time | t_s | 60 | 120 | s |
| 升温速率 Ramp-Up Rate (T_L to T_P) | - | - | 3 | $^\circ\text{C}/\text{s}$ |
| 液相线温度 Liquidus Temperature | T_L | 217 | | $^\circ\text{C}$ |
| 时间高于 T_L Time Above T_L | t_L | 60 | 150 | s |
| 峰值温度 Peak Temperature | T_P | - | 260 | $^\circ\text{C}$ |
| T_c 在 $(T_P - 5)$ 和 T_P 之间的时间 Time During Which T_c Is Between $(T_P - 5)$ and T_P | t_p | - | 30 | s |
| 降温速率 Ramp-down Rate (T_P to T_L) | - | - | 6 | $^\circ\text{C}/\text{s}$ |

注：建议在所示的温度和时间条件下进行回流焊，最多不能超过三次。

Note: Reflow soldering is recommended at the temperatures and times shown, no more than three times.

波峰焊温度曲线图 Wave Soldering Profile



手工烙铁焊接 Soldering with hand soldering iron

- A. 手工烙铁焊仅用于产品返修或样品测试;
Hand soldering iron is only used for product rework or sample testing;
- B. 手工烙铁焊要求: 温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$.
Manual soldering method Temperature: $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

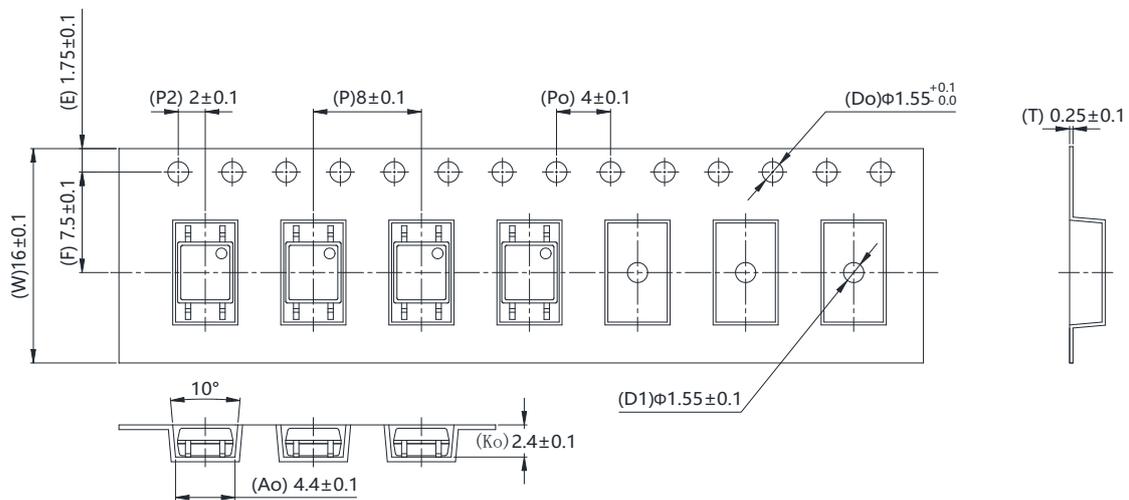
包装 Packing

■ 汇总表 Summary table

| 封装形式 | 包装方式 | 盘数量 | 盒数量 | 箱数量 | 静电袋规格 | 盒规格 | 箱(双瓦楞)规格 | 备注 |
|--------------|-----------------------|-------------------|------------------|---------------------|------------------------------|-------------------|----------------------|--|
| SOP4 | 卷盘 (φ330mm 蓝盘) | 3000 只/盘 | 2 盘/盒 | 10 盒/箱 | 450*390*0.1mm | 353*340*60 mm | 650*375*365mm | 首端空 50 个空格 末端空 100 个空格 |
| Package Type | Packing Form | Quantity per Reel | Quantity per Box | Quantity per Carton | Antistatic Bag Specification | Box Specification | Carton Specification | Note |
| SOP4 | Reel (φ330mm Blue) | 3000 pcs /reel | 2 reels /box | 10 boxes /ctn | 450*390*0.1mm | 353*340*60 mm | 650*375*365mm | Leave 50 Spaces at the beginning and 100 Spaces at the end |

■ 编带包装 Tape & Reel

- 1) 每卷数量: 3000 只。
Qty/reel: 3000 pcs.
- 2) 每箱数量: 60000 只。
Qty/ctn: 60000 pcs.
- 3) 内包装: 每盒 2 盘。
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



单位 Unit: mm

注意 Attention

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